

REPLY UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE  
TECHNOLOGY CENTER 2800

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

<b>Application No.:</b>	10/721,984	<b>Conf. No.:</b>	6936
<b>Applicant:</b>	Farooq et al.	<b>TC/AU:</b>	2826
<b>Filed:</b>	11/25/03	<b>Examiner:</b>	Williams, Alexander O.
		<b>Docket:</b>	END920030114US1 (IBME-0097)

**Title:** SEMICONDUCTOR MODULE  
AND METHOD FOR FORMING THE SAME

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AFTER FINAL AMENDMENT**

Sir:

**I. INTRODUCTORY COMMENTS:**

In response to the Final Office Action of June 6, 2006, please amend the above-referenced patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims that begins on page 2 of this paper.

**Remarks** begin on page 6 of this paper.